DATA SHEET

74LV74

Dual D-type flip-flop with set and reset; positive-edge trigger

Product specification Supersedes data of 1996 Nov 07 IC24 Data Handbook





Dual D-type flip-flop with set and reset; positive edge-trigger

74LV74

FEATURES

- Wide operating voltage: 1.0 to 5.5V
- Optimized for Low Voltage applications: 1.0 to 3.6V
- ullet Accepts TTL input levels between V_{CC} = 2.7V and V_{CC} = 3.6V
- Typical V_{OLP} (output ground bounce) < 0.8V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) > 2V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Output capability: standard
- I_{CC} category: flip-flops

DESCRIPTION

The 74LV74 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT74.

The 74LV74 is a dual positive edge triggered, D-type flip-flop with individual data (D) inputs, clock (CP) inputs, set (\overline{S}_D) and (\overline{R}_D) inputs; also complementary Q and \overline{Q} outputs.

The set and reset are asynchronous active LOW inputs and operate independently of the clock input. Information on the data input is transferred to the Q output on the LOW-to-HIGH transition of the clock pulse. The D inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition, for predictable operation.

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

QUICK REFERENCE DATA

GND = 0V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5 \text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay nCP to nQ, n \overline{Q} nS _D to nQ, n \overline{Q} n \overline{R}_D to nQ, n \overline{Q} n \overline{R}_D to nQ, n \overline{Q}	C _L = 15pF V _{CC} = 3.3V	11 14 14	ns
f _{max}	Maximum clock frequency	$C_L = 15pF$ $V_{CC} = 3.3V$	76	MHz
C _I	Input capacitance		3.5	pF
C _{PD}	Power dissipation capacitance per flip-flop	Notes 1 and 2	24	pF

NOTES:

- 1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)

 - $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: $f_i = \text{input frequency in MHz; } C_L = \text{output load capacitance in pF; } f_o = \text{output frequency in MHz; } V_{CC} = \text{supply voltage in V; } \Sigma (C_L \times V_{CC}^2 \times f_o) = \text{sum of the outputs.}$
- 2. The condition is $V_I = GND$ to V_{CC}

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	-40°C to +125°C	74LV74 N	74LV74 N	SOT27-1
14-Pin Plastic SO	-40°C to +125°C	74LV74 D	74LV74 D	SOT108-1
14-Pin Plastic SSOP Type II	-40°C to +125°C	74LV74 DB	74LV74 DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV74 PW	74LV74PW DH	SOT402-1

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1, 13	1R _{D,} 2R _D	Asynchronous reset-direct input (active-LOW)
2, 12	1D, 2D	Data inputs
3, 11	1CP, 2CP	Clock input (LOW-to-HIGH), edge-triggered)
4, 10	1\$ _{D,} 2\$ _D	Asynchronous set-direct input (active-LOW)
5, 9	1Q, 2Q	True flip-flop outputs
6, 8	1 <u>Q</u> , 2 <u>Q</u>	Complement flip-flop outputs
7	GND	Ground (0V)
14	V _{CC}	Positive supply voltage

FUNCTION TABLE

INPUTS

l					
S _D	\overline{R}_{D}	СР	D	Q	Q
L H L	H L L	X X X	X X X	H	L H H
	INPU	TS		OUTI	PUTS
<u></u> S _D	INPU R _D	TS CP	D	OUTI Q _{n+1}	PUTS Q _{n+1}
S _D H H			D L H		

OUTPUTS

HIGH voltage level LOW voltage level

= don't care

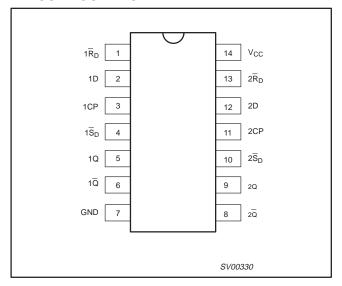
= LOW-to-HIGH CP transition

 Q_{n+1} = state after the next LOW-to-HIGH CP transition

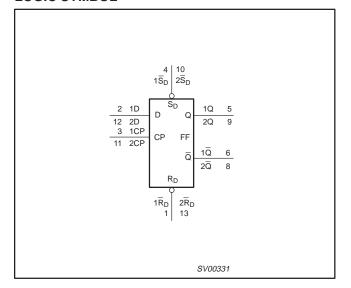
Dual D-type flip-flop with set and reset; positive edge-trigger

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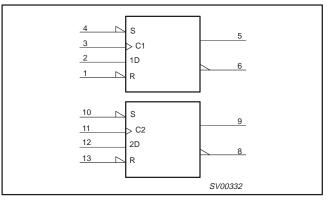
PIN CONFIGURATION



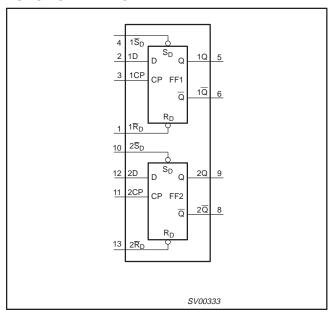
LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



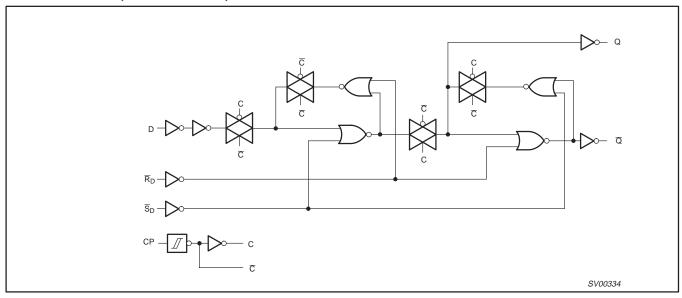
FUNCTIONAL DIAGRAM



Dual D-type flip-flop with set and reset; positive edge-trigger

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LOGIC DIAGRAM (ONE FLIP-FLOP)



RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V _{CC}	DC supply voltage	See Note1	1.0	3.3	5.5	V
V _I	Input voltage		0	-	V _{CC}	V
Vo	Output voltage		0	-	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times except for Schmitt-trigger inputs	$\begin{array}{c} V_{CC} = 1.0 \text{V to } 2.0 \text{V} \\ V_{CC} = 2.0 \text{V to } 2.7 \text{V} \\ V_{CC} = 2.7 \text{V to } 3.6 \text{V} \\ V_{CC} = 3.6 \text{V to } 5.5 \text{V} \end{array}$	- - -	- - - -	500 200 100 50	ns/V

NOTE

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
±I _{IK}	DC input diode current	$V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5V$	20	mA
±I _{OK}	DC output diode current	$V_{O} < -0.5 \text{ or } V_{O} > V_{CC} + 0.5V$	50	mA
±ΙΟ	DC output source or sink current – standard outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25	mA
±I _{GND} , ±I _{CC}	DC V _{CC} or GND current for types with –standard outputs		50	mA
T _{stg}	Storage temperature range		-65 to +150	°C
	Power dissipation per package	for temperature range: -40 to +125°C		
D	-plastic DIL	above +70°C derate linearly with 12mW/K	750	mW
P _{tot}	-plastic mini-pack (SO)	above +70°C derate linearly with 8 mW/K	500	11100
	-plastic shrink mini-pack (SSOP and TSSOP)	above +60°C derate linearly with 5.5 mW/K	400	

NOTES:

^{1.} The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.

^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC CHARACTERISTICS

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40)°C to +8	5°C	-40°C to	+125°C	UNIT
			MIN	TYP ¹	MAX	MIN	MAX	1
		V _{CC} = 1.2V	0.9			0.9		
W	HIGH level Input	V _{CC} = 2.0V	1.4			1.4		
V_{IH}	voltage	V _{CC} = 2.7 to 3.6V	2.0			2.0		1
		V _{CC} = 4.5 to 5.5V	0.7*V _{CC}			0.7*V _{CC}		1
		V _{CC} = 1.2V			0.3		0.3	
V _{IL}	LOW level Input	V _{CC} = 2.0V			0.6		0.6]
V IL	voltage	V _{CC} = 2.7 to 3.6V			0.8		0.8	1
		V _{CC} = 4.5 to 5.5			0.3*V _{CC}		0.3*V _{CC}	1
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$		1.2				
	LUCITION I STATE	$V_{CC} = 2.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	1.8	2.0		1.8		1
V _{OH}	HIGH level output voltage; all outputs	$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	2.5	2.7		2.5		V
	Tomago, am outputo	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$	2.8	3.0		2.8]
		$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu A$	4.3	4.5		4.3]
V _{OH}	HIGH level output voltage;	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 6\text{mA}$	2.40	2.82		2.20		V
▼OH	STANDARD outputs	$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 12\text{mA}$	3.60	4.20		3.50		
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0				
	LOW level output	$V_{CC} = 2.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		0	0.2		0.2]
V_{OL}	voltage; all outputs	$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		0	0.2		0.2	V
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2]
		$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2	
V _{OL}	LOW level output voltage;	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 6\text{mA}$		0.25	0.40		0.50	V
VOL	STANDARD outputs	$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 12\text{mA}$		0.35	0.55		0.65]
II	Input leakage current	$V_{CC} = 5.5V$; $V_I = V_{CC}$ or GND			1.0		1.0	μА
I _{CC}	Quiescent supply current; flip-flops	$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		80	μА
Δl _{CC}	Additional quiescent supply current per input	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$			500		850	μА

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NOTE:

^{1.} All typical values are measured at $T_{amb} = 25$ °C.

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AC CHARACTERISTICS

GND = 0V; $t_r = t_f \le 2.5$ ns; $C_L = 50$ pF; $R_L = 1$ K Ω

SYMBOL	PARAMETER	WAVEFORM	CONDITION		LIMITS 40 to +85 °	С		IITS +125 °C	UNIT
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX	
			1.2		70	-	_	-	
			2.0	_	24	44	-	56	
t _{PHL/} t _{PLH}	Propagation delay nCP to nQ, n \overline{Q}	Figures, 1, 3	2.7	-	18	28	-	41	ns
	1101 10110, 110		3.0 to 3.6		13 ²	26	_	33	
			4.5 to 5.5	_	9.5 ³	17	_	23	
			1.2	-	90	-	-	-	
			2.0	-	31	46	-	58	
t _{PHL} /t _{PLH}	Propagation delay nS _D to nQ, nQ	Figures 2, 3	2.7	_	23	34	-	43	ns
	1100 10 110, 110		3.0 to 3.6	-	17 ²	27	-	34	
			4.5 to 5.5	-	12 ³	19	-	24	
			1.2	-	90	-	-	-	
			2.0	_	31	46	-	58	
t _{PHL} /t _{PLH}	Propagation delay nR _D to nQ, nQ	Figures 2, 3	2.7	-	23	34	-	43	ns
	IIND to fice, fice		3.0 to 3.6	_	17 ²	27	-	34	
			4.5 to 5.5	_	12 ³	19	-	24	
			2.0	34	10	_	41	-	
	Clock pulse width	_, ,	2.7	25	8	-	30	-	
t₩	HIGH to LOW	Figure 1	3.0 to 3.6	20	7 ²	-	24	- 1	ns
			4.5 to 5.5	15	6 ³	-	18	T - 1	
			2.0	34	10	-	41	-	
	Set or reset pulse		2.7	25	8	-	30	- 1	
t _W	width LOW	Figure 2	3.0 to 3.6	20	7 ²	-	24	T - 1	ns
			4.5 to 5.5	15	6 ³	-	18	T - 1	
			1.2	-	5	-	_	- 1	
			2.0	14	2	-	15	T - 1	
t _{rem}	Removal time	Figure 2	2.7	10	1	-	11	T - 1	ns
10111	set or reset		3.0 to 3.6	8	1 ²	-	9	<u> </u>	
			4.5 to 5.5	6	1 ³	-	7	-	
		+ +	1.2	-	10	-	_	-	
		-	2.0	22	4	-	26	-	
t _{su}	Set-up time	Figure 1	2.7	12	3	-	15	-	ns
Ju	nD to nCP		3.0 to 3.6	8	22	-	10	-	
			4.5 to 5.5	6	1 ²	-	8	-	
		+ +	1.2	-	-10	-	_	-	
			2.0	3	-2	_	3	-	
t _h	Hold time	Figure 1	2.7	3	-2	_	3	-	ns
711	nD to nCP	"	3.0 to 3.6	3	-2 ²	_	3	-	
			4.5 to 5.5	3	-2 ³	_	3	-	
		+	2.0	14	40	_	12	-	
	Maximum clock		2.7	50	90	_	40	_	
f_{max}	pulse frequency	Figure 1	3.0 to 3.6	60	100 ²	_	48	_	MH
		ı ⊢	4.5 to 5.5	70	110 ³	_	56	-	

NOTE:

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^{1.} Unless otherwise stated, all typical values are at T_{amb} = 25°C.

^{2.} Typical value measured at V_{CC} = 3.3V.

^{3.} Typical value measured at $V_{CC} = 5.0V$.

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AC WAVEFORMS

 V_M = 1.5V at $V_{CC} \ge 2.7V \le 3.6V$ V_M = 0.5 * V_{CC} at $V_{CC} < 2.7V$ and $\ge 4.5V$

 $\rm V_{OL}^{}$ and $\rm V_{OH}^{}$ are the typical output voltage drop that occur with the output load.

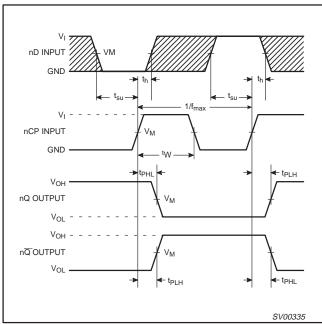


Figure 1.The clock (nCP) to output (nQ, $n\overline{Q}$) propagation delays, the clock pulse width, the nD to nCP setup times, the nCP to nD hold times, the output transition times and the maximum clock pulse frequency

NOTE:

The shaded areas indicate when the input is permitted to change for predictable output performance.

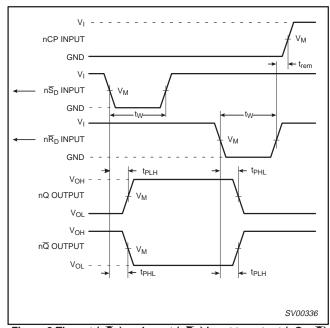


Figure 2.The set $(n\overline{S}_D)$ and reset $(n\overline{R}_D)$ input to output $(nQ, n\overline{Q})$ propagation delays, the set and reset pulse widths and the $n\overline{R}_D$ to nCP removal time

TEST CIRCUIT

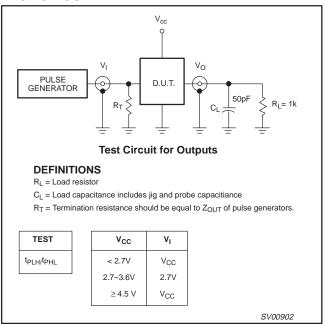


Figure 3. Load circuitry for switching times

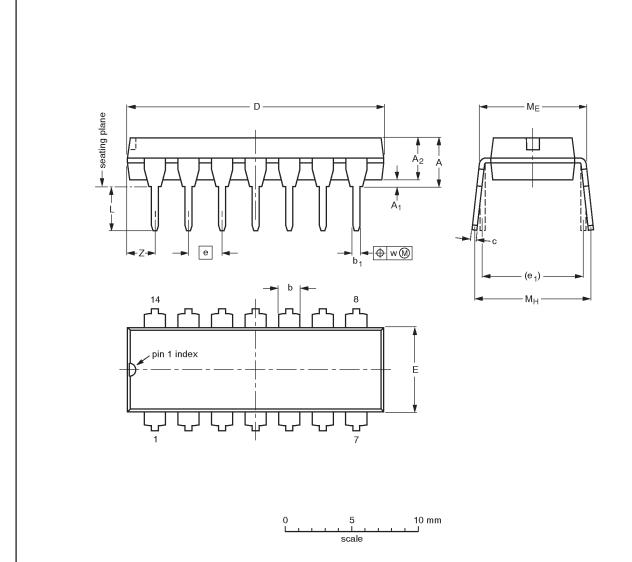
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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

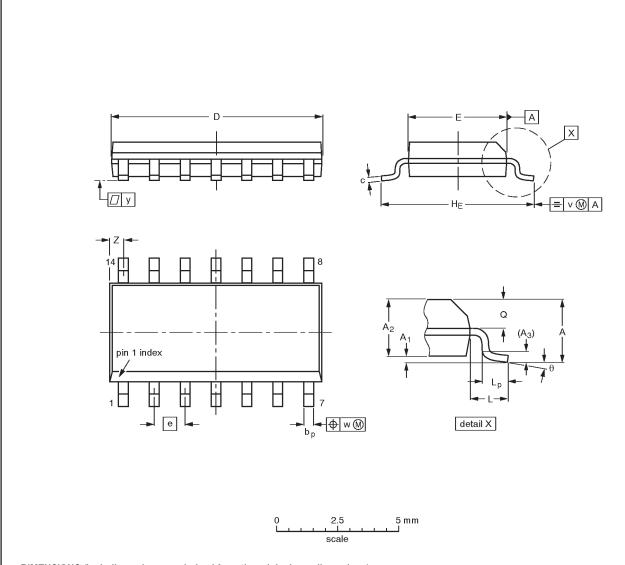
OUTLINE		REFER	RENCES		EUROPEAN	ICCUE DATE	
VERSION	IEC	IEC JEDEC EIAJ			PROJECTION	ISSUE DATE	
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11	

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Ø	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01		0.0098 0.0075		0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

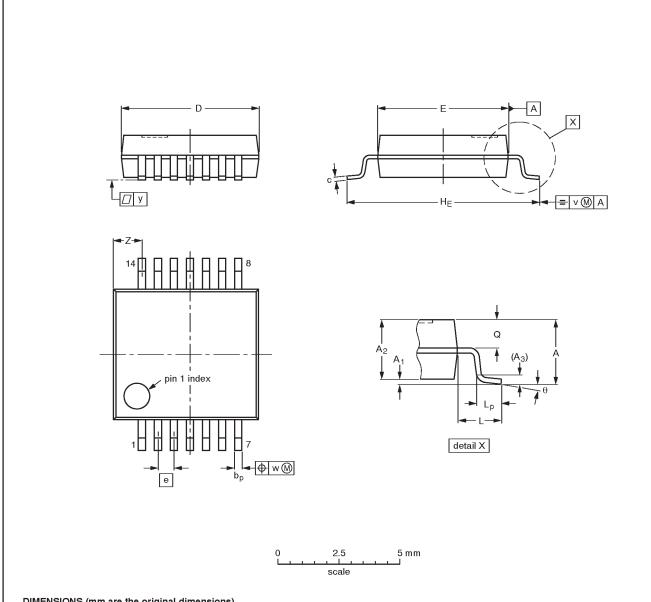
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VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT108-1	076E06S	MS-012AB			91-08-13 95-01-23

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	c	D ⁽¹⁾	E ⁽¹⁾	e	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

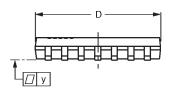
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SOT337-1		MO-150AB			95-02-04 96-01-18	

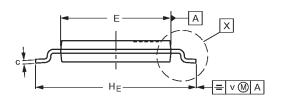
Dual D-type flip-flop with set and reset; positive edge-trigger

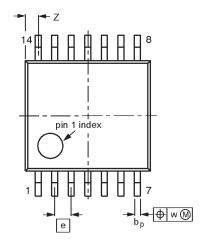
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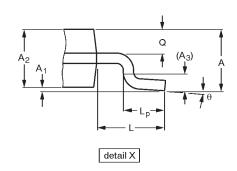
TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

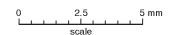
SOT402-1











DIMENSIONS (mm are the original dimensions)

UN	IT	A max.	Α1	A ₂	A ₃	рb	c	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Ø	v	w	у	Z ⁽¹⁾	θ
mı	n	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE				
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	١
SOT402-1		MO-153				-94-07-12 95-04-04	

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DEFINITIONS							
Data Sheet Identification	Product Status	Definition					
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.					
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.					
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print code Date of release: 05-96

Document order number: 9397-750-04414

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